

Insulated Gate Bi-Polar Transistor

Type T1800GB45A

Absolute Maximum Ratings

| | VOLTAGE RATINGS | MAXIMUM LIMITS | UNITS |
|----------------|--|----------------|-------|
| V_{CES} | Collector – emitter voltage | 4500 | V |
| $V_{DC\ link}$ | Permanent DC voltage for 100 FIT failure rate. | 2800 | V |
| V_{GES} | Peak gate – emitter voltage | ±20 | V |

| | RATINGS | MAXIMUM LIMITS | UNITS |
|----------------|--|----------------|------------|
| I_C | DC collector current, IGBT | 1800 | A |
| I_{CRM} | Repetitive peak collector current, $t_p=1ms$, IGBT | 3600 | A |
| $I_{F(DC)}$ | Continuous DC forward current, Diode | 1800 | A |
| I_{FRM} | Repetitive peak forward current, $t_p=1ms$, Diode | 3600 | A |
| I_{FSM} | Peak non-repetitive surge $t_p=10ms$, $V_{RM}=60\%V_{RRM}$, Diode (Note 4) | 38.6 | kA |
| I_{FSM2} | Peak non-repetitive surge $t_p=10ms$, $V_{RM}\leq 10V$, Diode (Note 4) | 42.5 | kA |
| P_{MAX} | Maximum power dissipation, IGBT (Note 2) | 13.7 | kW |
| $(di/dt)_{cr}$ | Critical diode di/dt (note 3) | 3500 | A/ μs |
| T_j | Operating temperature range. | -40 to +125 | °C |
| T_{stg} | Storage temperature range. | -40 to +125 | °C |

Notes: -

- 1) Unless otherwise indicated $T_j = 125^\circ C$.
- 2) $T_{sink} = 25^\circ C$, double side cooled.
- 3) Maximum commutation loop inductance 200nH.
- 4) Half-sinewave, $125^\circ C$ T_j initial.

Characteristics

IGBT Characteristics

| | PARAMETER | MIN | TYP | MAX | TEST CONDITIONS | UNITS |
|----------------------|--|-----|------|------|--|-------|
| V _{CE(sat)} | Collector – emitter saturation voltage | - | 2.8 | 3.2 | I _C = 1800A, V _{GE} = 15V, T _j = 25°C | V |
| | | - | 3.6 | 4.0 | I _C = 1800A, V _{GE} = 15V | V |
| V _{T0} | Threshold voltage | - | - | 1.82 | Current range: 600A – 1800A | V |
| r _T | Slope resistance | - | - | 1.21 | | mΩ |
| V _{GE(TH)} | Gate threshold voltage | - | 5.1 | - | V _{CE} = V _{GE} , I _C = 180mA | V |
| I _{CES} | Collector – emitter cut-off current | - | 45 | 70 | V _{CE} = V _{CES} , V _{GE} = 0V | mA |
| I _{GES} | Gate leakage current | - | - | ±20 | V _{GE} = ±20V | µA |
| C _{ies} | Input capacitance | - | 280 | - | V _{CE} = 25V, V _{GE} = 0V, f = 1MHz | nF |
| t _{d(on)} | Turn-on delay time | - | 1.5 | - | I _C = 1800A, V _{CE} = 2800V, di/dt = 3000A/µs | µs |
| t _{r(V)} | Rise time | - | 3.3 | - | | µs |
| Q _{g(on)} | Turn-on gate charge | - | 12.5 | - | V _{GE} = ±15V, L _S = 200nH | µC |
| E _{on} | Turn-on energy | - | 11 | - | R _{g(ON)} = 3Ω, R _{g(OFF)} = 11Ω, C _{GE} = 183nF | J |
| t _{d(off)} | Turn-off delay time | - | 4.7 | - | Integral diode used as freewheel diode (Note 3 & 4) | µs |
| t _{f(l)} | Fall time | - | 2.5 | - | | µs |
| Q _{g(off)} | Turn-off gate charge | - | 10 | - | | µC |
| E _{off} | Turn-off energy | - | 10.5 | - | | J |
| I _{sc} | Short circuit current | - | 5500 | - | V _{GE} = +15V, V _{CC} = 2800V, V _{CEmax} ≤ V _{CES} , t _p ≤ 10µs | A |

Diode Characteristics

| | PARAMETER | MIN | TYP | MAX | TEST CONDITIONS | UNITS |
|-----------------|----------------------------------|-----|------|------|---|-------|
| V _F | Forward voltage | - | 3.7 | 4.0 | I _F = 1800A, T _j = 25°C | V |
| | | - | 3.9 | 4.2 | I _F = 1800A | V |
| V _{T0} | Threshold voltage | - | - | 2.27 | Current range 600A - 1800A | V |
| r _T | Slope resistance | - | - | 1.07 | | mΩ |
| I _{rm} | Peak reverse recovery current | - | 1600 | - | I _F = 1800A, V _r = 2800V, V _{GE} = -15V, di/dt = 3000A/µs | A |
| Q _{rr} | Recovered charge | - | 2000 | - | | µC |
| t _{rr} | Reverse recovery time, 50% chord | - | 1.6 | - | µs | |
| E _r | Reverse recovery energy | - | 2.8 | - | J | |

Thermal Characteristics

| | PARAMETER | MIN | TYP | MAX | TEST CONDITIONS | UNITS |
|-------------------|--|-----|-----|------|-----------------------|-------|
| R _{thJK} | Thermal resistance junction to sink, IGBT | - | - | 7.3 | Double side cooled | K/kW |
| | | - | - | 11.9 | Collector side cooled | K/kW |
| | | - | - | 19 | Emitter side cooled | K/kW |
| R _{thJK} | Thermal resistance junction to sink, Diode | - | - | 14.4 | Double side cooled | K/kW |
| | | - | - | 22.3 | Cathode side cooled | K/kW |
| | | - | - | 41.1 | Anode side cooled | K/kW |
| F | Mounting force | 50 | - | 70 | Note 2 | kN |
| W _t | Weight | - | 2 | - | | kg |

Notes:-

- 1) Unless otherwise indicated T_j = 125°C.
- 2) Consult application note 2008AN01 for detailed mounting requirements
- 3) C_{GE} is additional gate – emitter capacitance added to output of gate drive
- 4) Figures 6 to 9 are obtained using integral diode as freewheeling diode

Curves

Figure 1 – Typical collector-emitter saturation voltage characteristics

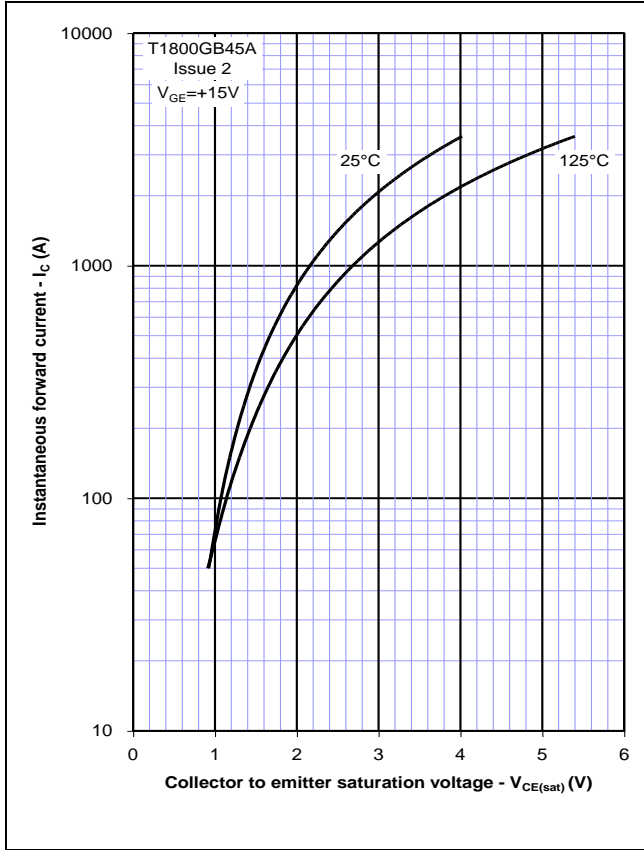


Figure 2 – Typical output characteristic

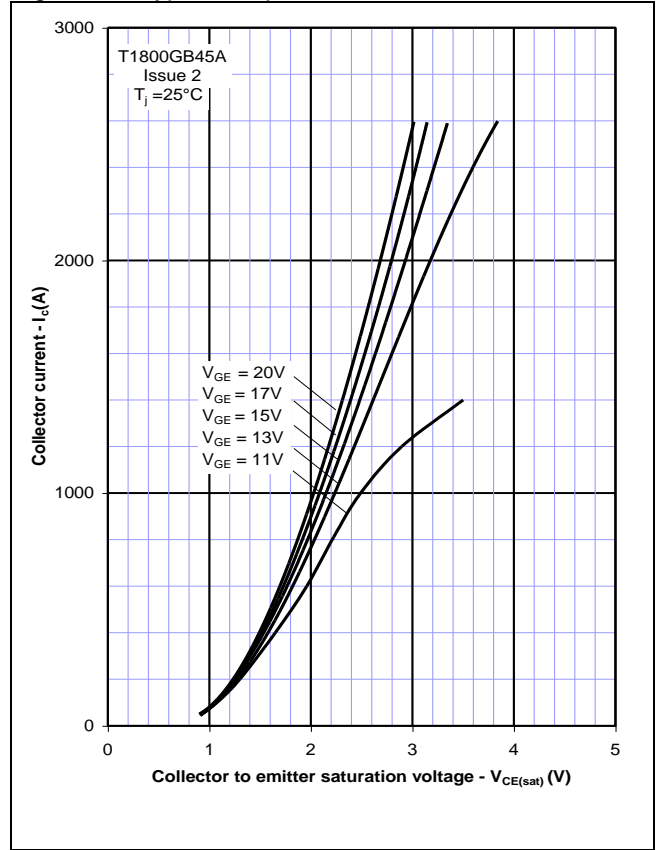


Figure 3 – Typical output characteristic

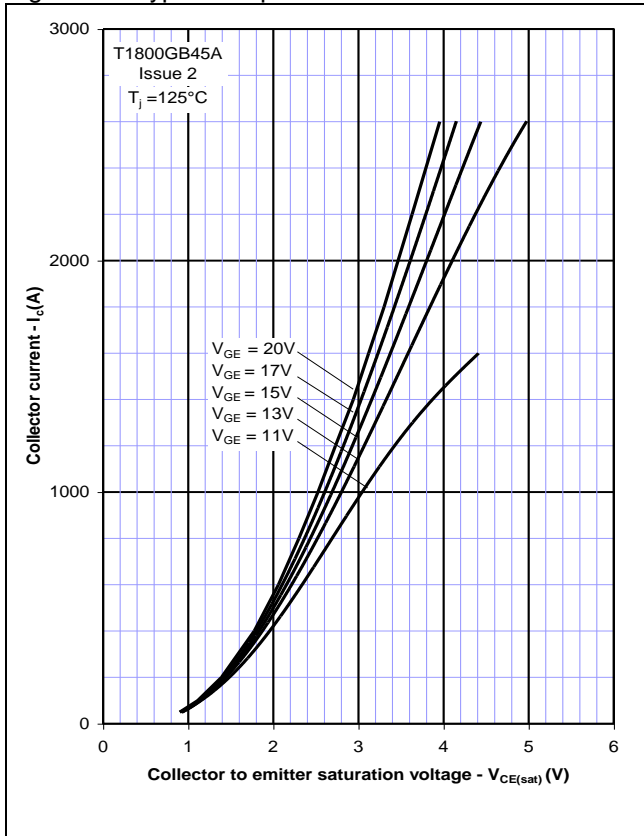


Figure 4 – Typical turn-on delay time vs gate resistance

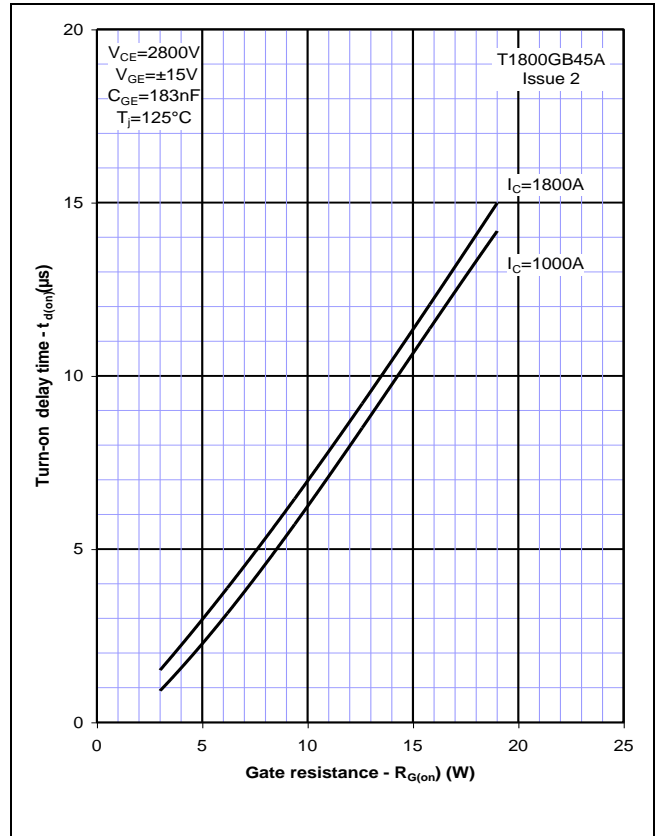


Figure 5 – Typical turn-off delay time vs. gate resistance

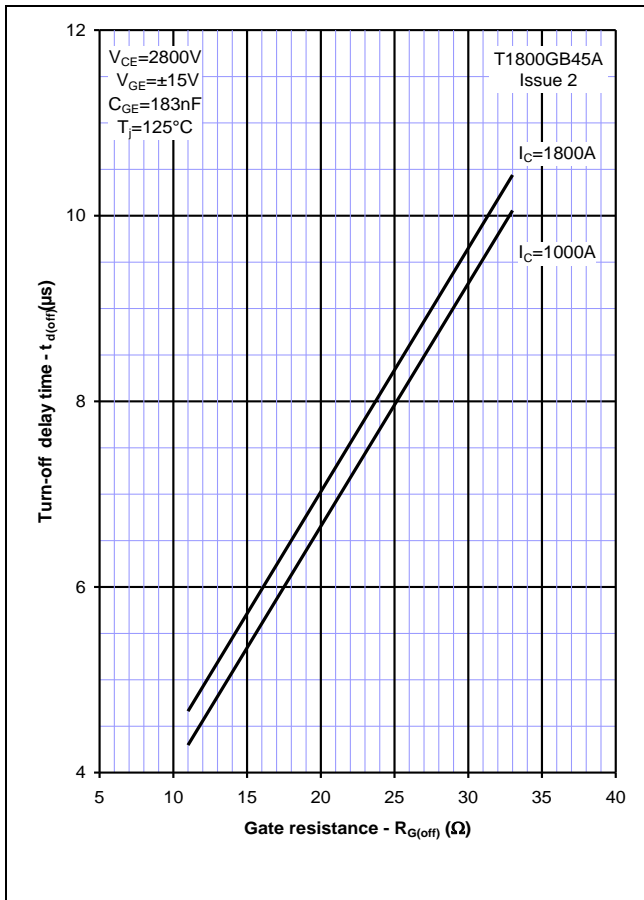


Figure 6 – Typical turn-on energy vs. collector current

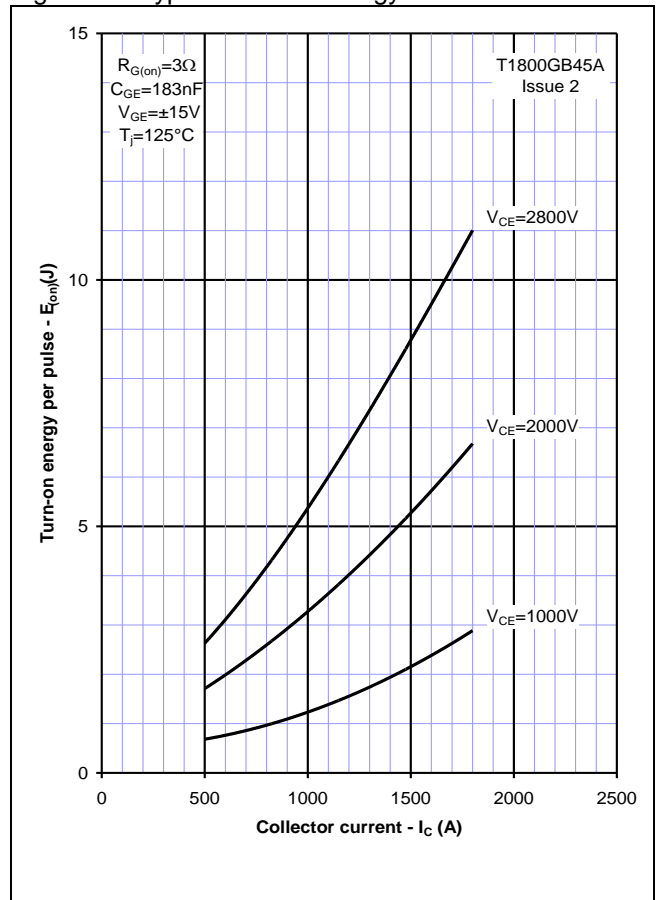


Figure 7 – Typical turn-on energy vs. di/dt

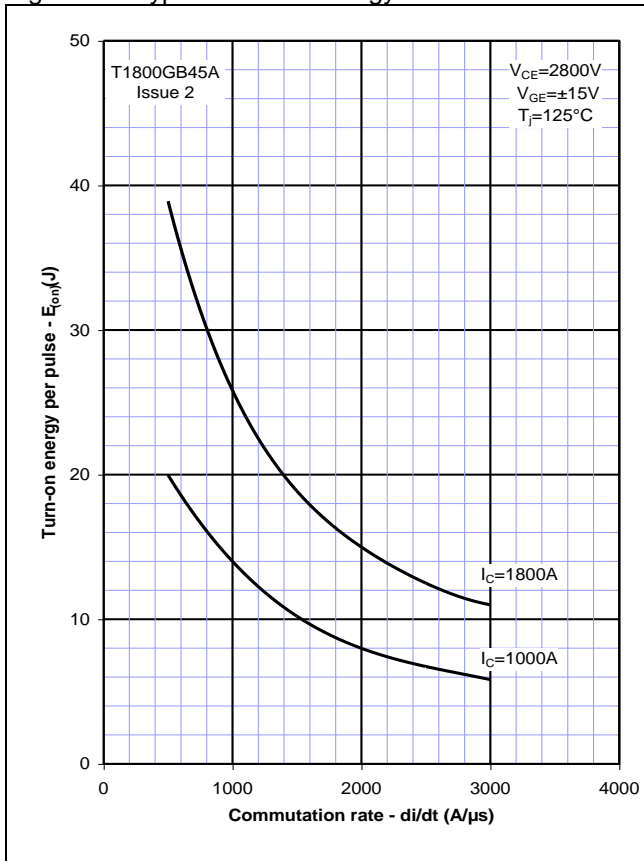


Figure 8 – Typical turn-off energy vs. collector current

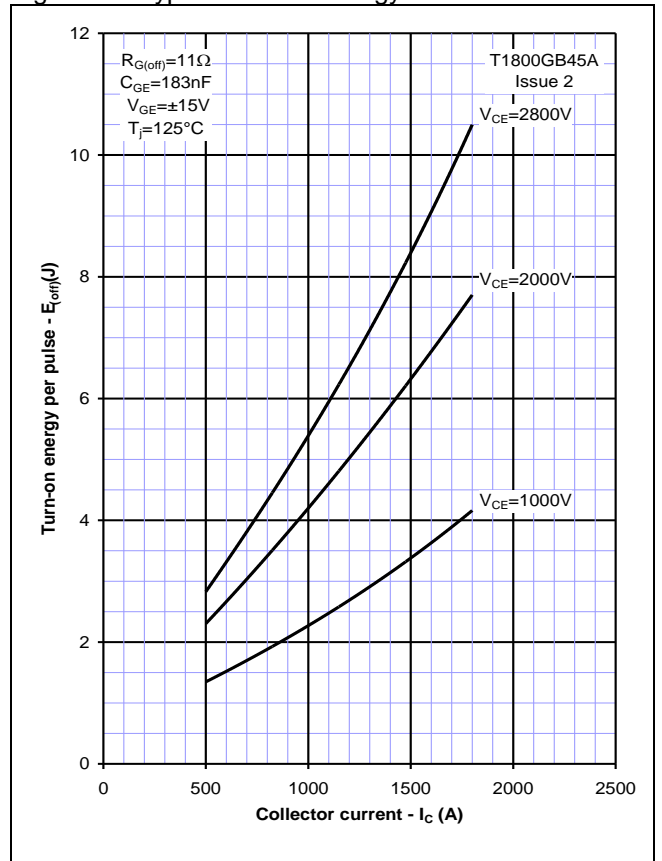


Figure 9 – Turn-off energy vs voltage

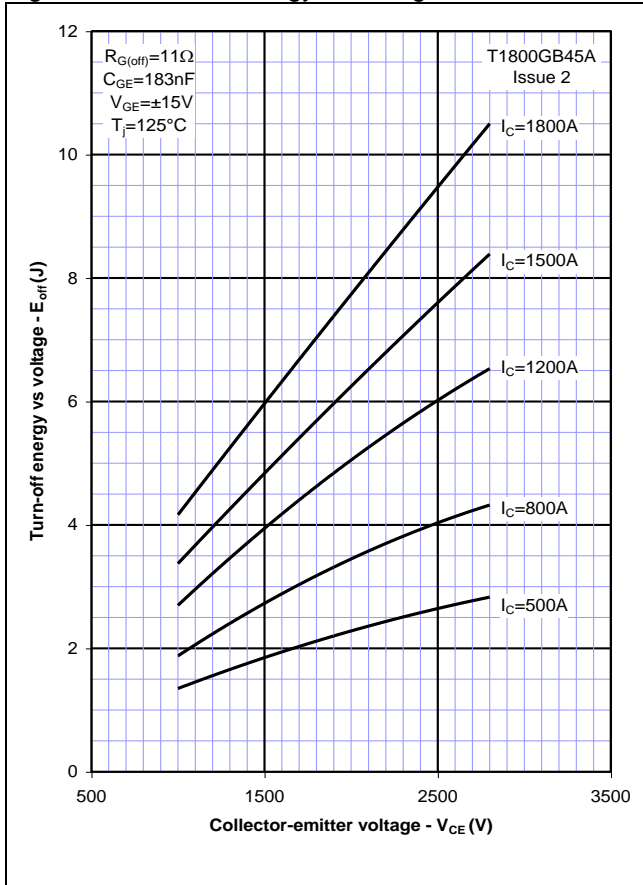


Figure 10 – Safe operating area (IGBT)

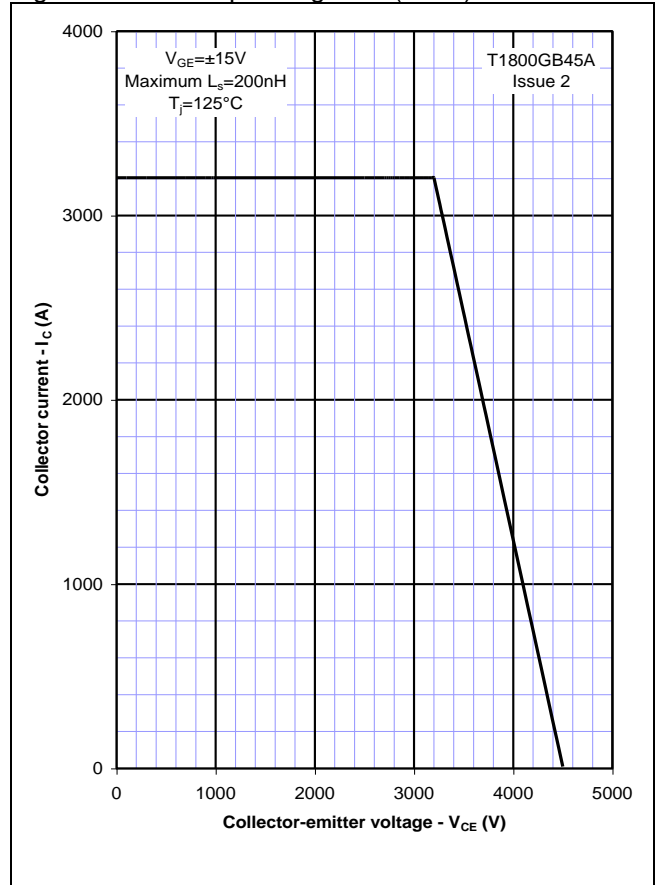


Figure 11 – Typical diode forward characteristics

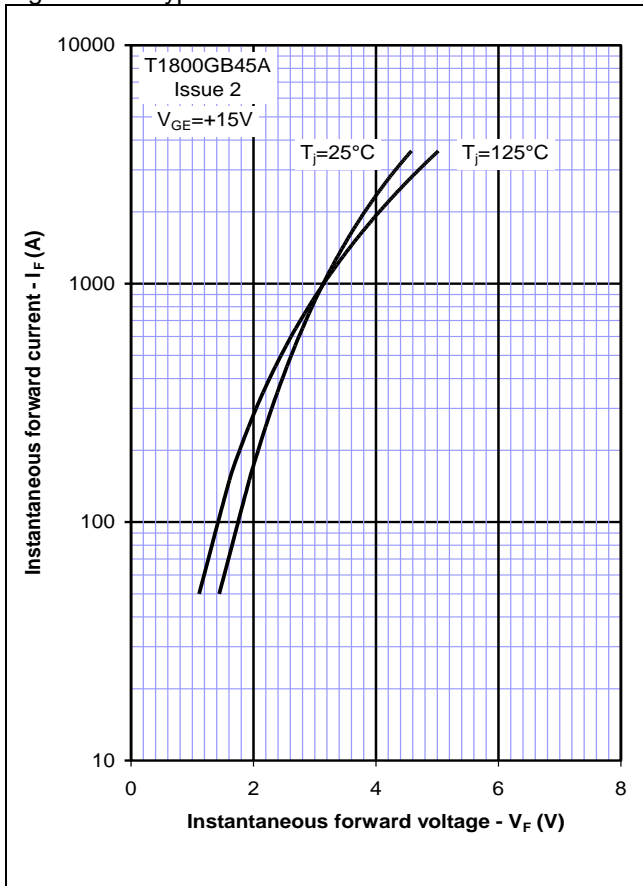


Figure 12 – Typical recovered charge

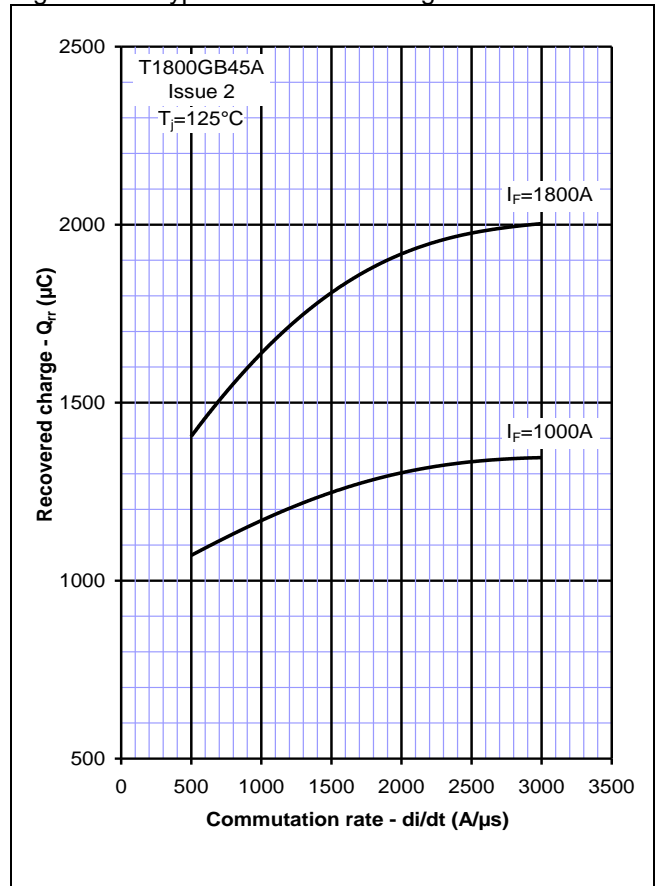


Figure 13 – Typical reverse recovery current

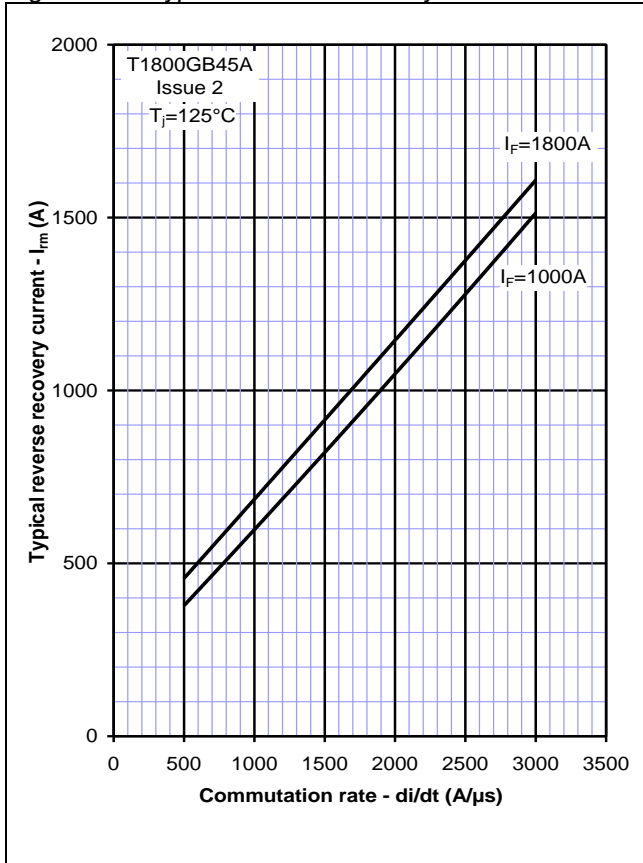


Figure 14 – Typical reverse recovery time

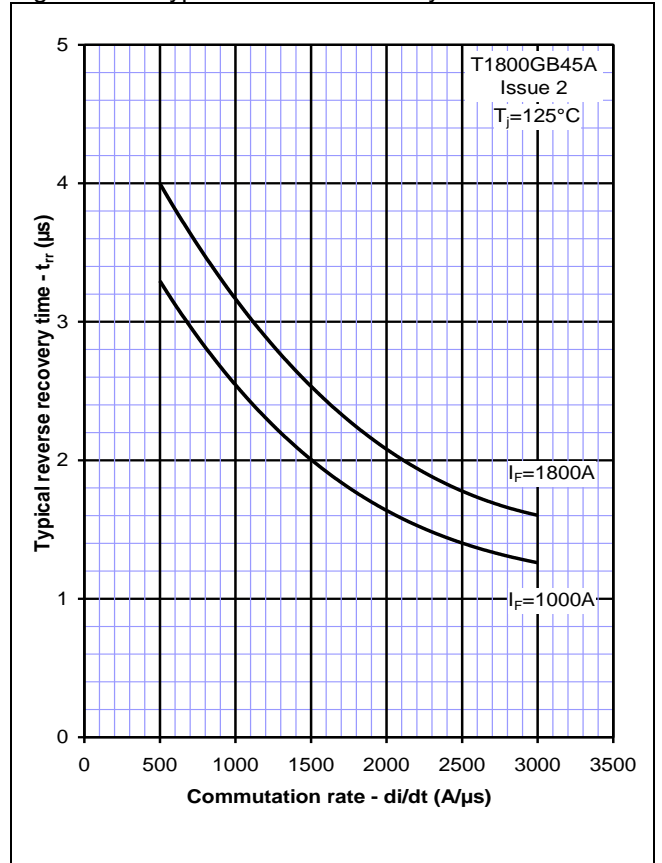


Figure 15 – Typical reverse recovery energy

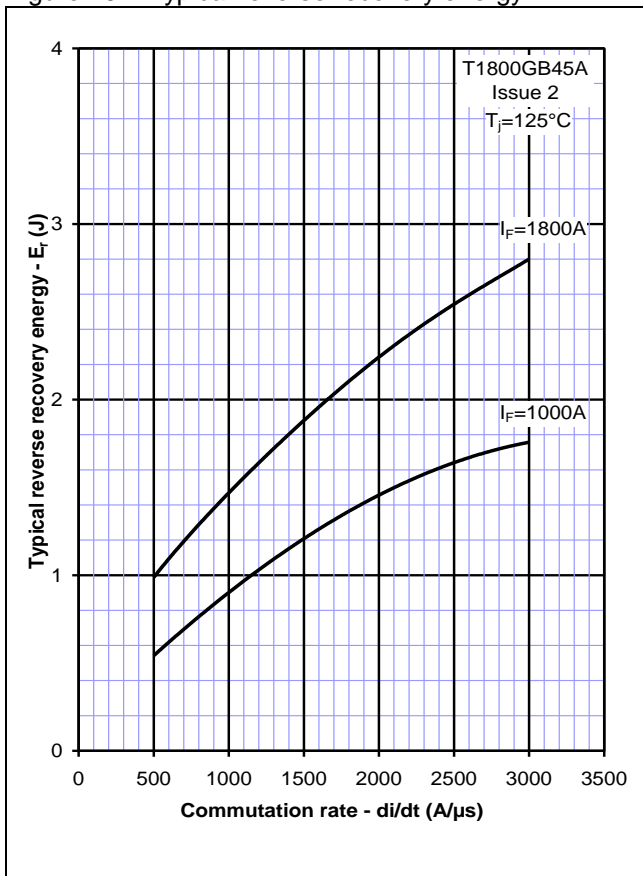


Figure 16 – Safe operating area (Diode)

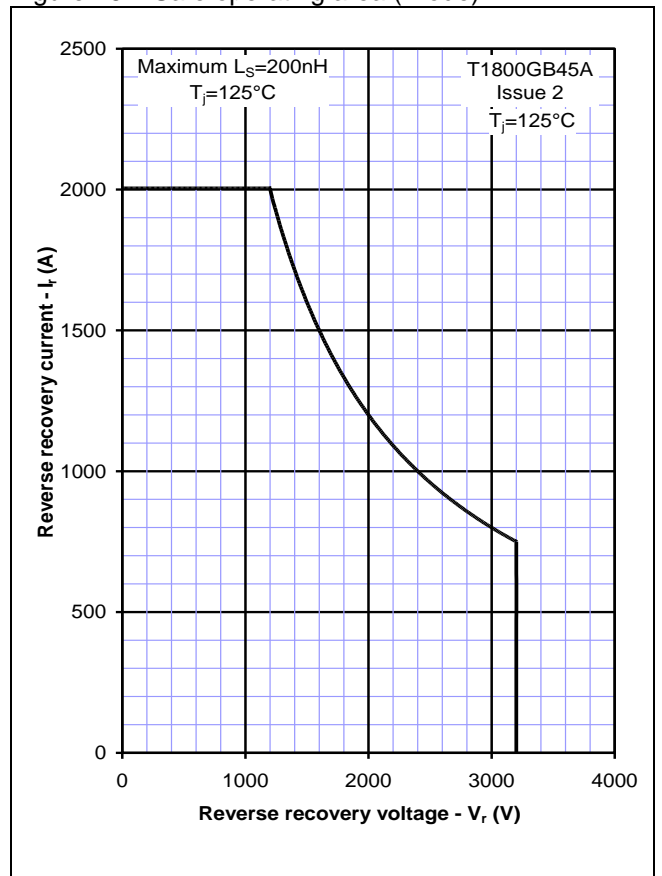


Figure 17 – Transient thermal impedance (IGBT)

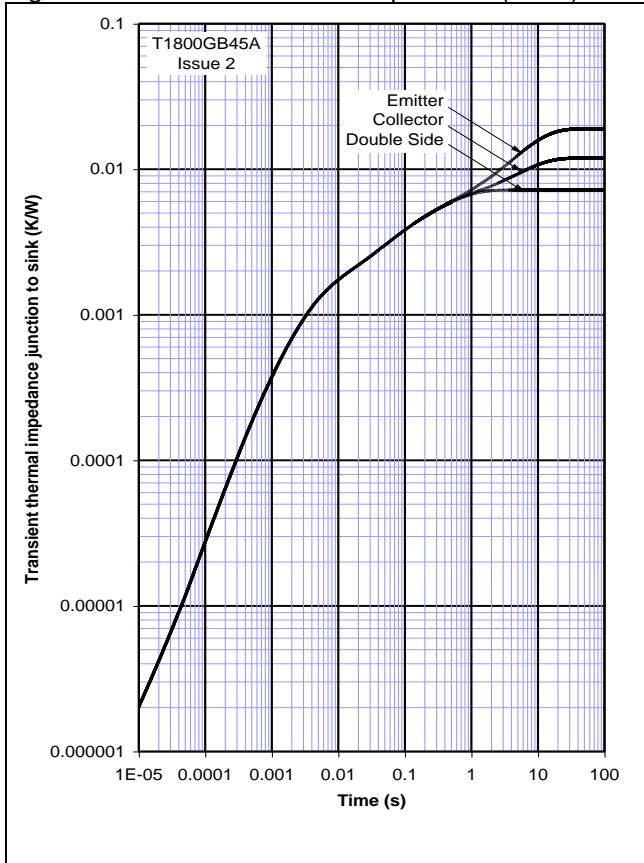
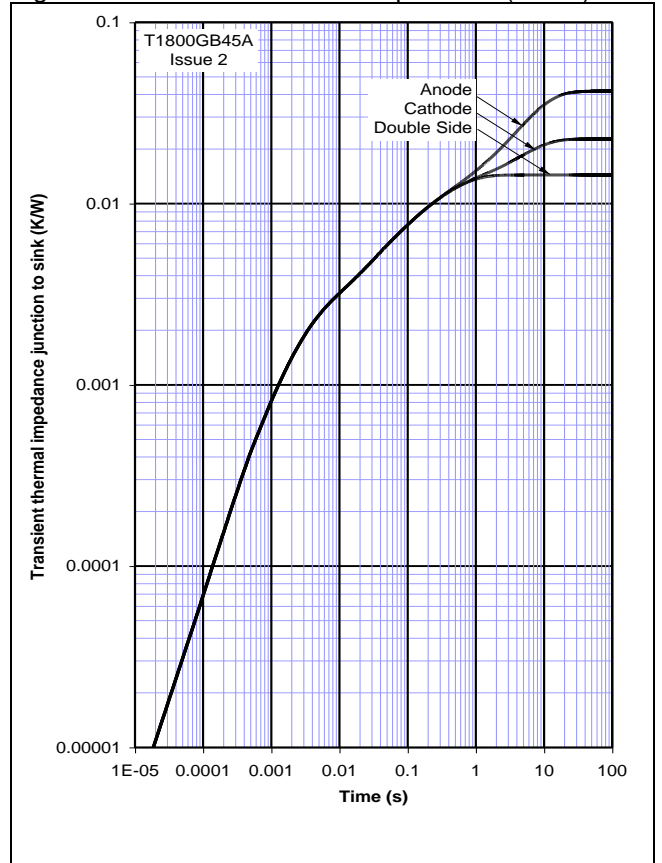
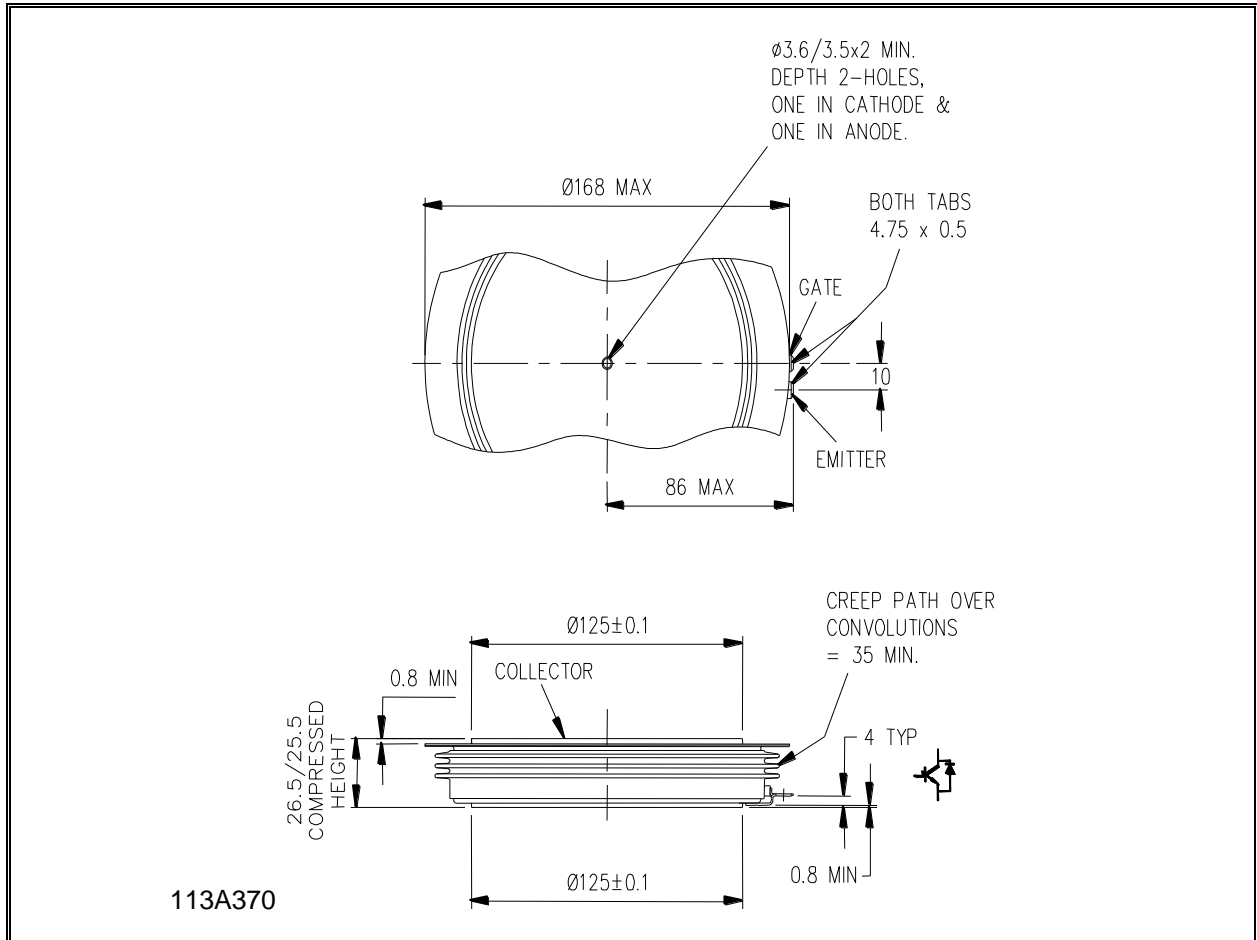


Figure 18 – Transient thermal impedance (Diode)



Outline Drawing & Ordering Information



| ORDERING INFORMATION | | | |
|--|--------------------|--------------------------------------|-------------------|
| (Please quote 10 digit code as below) | | | |
| T1800 | GB | 45 | A |
| Fixed type Code | Fixed Outline Code | Voltage Grade $V_{CES}/100$ 45 | Fixed format code |
| Typical order code: T1800GB45A ($V_{CES} = 4500V$) | | | |

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